

Using the Flash Bootload Capability of the TMS320VC5402 DSK

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ABSTRACT

Developing a routine for the TMS320VC5402 board is relatively straightforward. Creating a bootable routine and generating the Hex file to burn it into the Flash are also straightforward tasks. This short document walks a developer through the procedure in relatively simple terms.

Materials Needed

TMS320VC5402 DSP starter kit (DSK) and Code Composer Studio[™] for the DSK, HEX500 utility (included with CCS) and the FLASHU utility (included with DSK).

Verify

Once a program has been developed, it should be verified functional by running it and checking to see if the results are correct.

Create a Vector Table

The vector table is used to identify the program's starting address after reset. Additionally, when the DSP is finished bootloading, it needs a known location to start from. The reset vector holds the address of where the program's code starts and will always be present. However, some development for the DSK can occur without a vector table (also known as an interrupt vector table). Generally, it is a good practice to have a vector table. Below is a basic vector table that can be used in a 'C' routine.

.sect "vectors" .global _c_int00, start start: b _c_int00 nop nop

Verify the Memory Map and Location of Sections

For proper operation after bootloading, the memory map needs to be properly set up. Proper location of the vectors section, .data, .text, etc. is essential. The bootloader routine will place these sections in memory based on the information defined and linked. The default location for the interrupt vectors, for instance, is 0xFF80. However, depending on the configuration of the DSP and the system, this may not be a valid address. For the DSK on power up, MC/MP* is typically 0. This means that 0xFF80 is located in the on-chip ROM. This area cannot be written to. The interrupt vector table will most likely need to be relocated to internal memory at some RAM location. A good rule of thumb is to locate the vector table at 0x0080, then the program can start.

Verify the Operating Mode of the Memories Needed for the DSK

If the FLASHENB bit is set in the CNTL2 register (located at I/O location 0x4), then the external memory on the DSK is set to Flash. This enables the entire program and data sections to fit into the internal memory for proper operation. At bootup, the FLASHENB is set. This allows the bootload to occur from Flash.

For a non-BIOS program, the following Linker command file is a good example.

```
-C
-stack 0x0256
-heap 0x0256
MEMORY
{
  PAGE 0: VECS: origin = 0080h, length = 0080h
              origin = 200h, length = 2000h
        PROG:
  PAGE 1: DATA: origin = 0x2200, length = 1e00h
}
* /
/* DSP Memory Allocation
SECTIONS
{
   .text > PROG PAGE = 0
.data > DATA PAGE = 1
.cinit > PROG PAGE = 0
    .bss >
              DATA PAGE = 1
    vectors >
              VECS PAGE = 0
}
```

The memory maps for the VC5402 DSK can be found in the Help files. Click on <Help><General Help>. Then under the contents tab, click on <TMS320C5402 DSK> <DSK memory maps and control registers>. There is information on the program memory map, the data and I/O memory maps.

Verify Project Build Options

It is important that the project options are set correctly to properly build your routine and make it bootable. One element that is critical in the setup of the project options is the –v 548 option. This is a compiler/assembler option that communicates to the hex utility which type of booloader to run. Any TMS320VC54x[™] devices (including the VC5402) need this option set for proper creation of the boot tables and hex file.

Verify With These Modifications That the Routine Still Runs

It would be good practice at this point to recompile the routine and re-verify its functionality. Since the linker command file and the compiler/assembler options were changed, verifying the program's functionality at this point could help expose any mistakes that may have occurred.

Create a HEX File

Using the HEX500 utility create a bootable hex file for the routine. The following options are necessary for creating a bootable file.

yours.out /*	Name	of obj file to be converted */
-ml	/*	Motorola s1 record format */
-memwidth 16	/*	Memory width target memory: 16 bits */
-romwidth 16	/*	Memory width Flash memory: 16 bits */
-boot	/*	create a boot table */
-bootorg 8000	h /*	Boot info starts at 8000h in data */
-e 80h	/*	This is the entry point reset vector */

Note that the address for bootorg can start anywhere in the Flash. The entry point can be anywhere in the routine; however, it makes more sense to have it located at the reset vector. In the case above, the vector table has been relocated to 0x0080.

Creating a command file for the HEX500 utility is prudent to reduce typing mistakes. The above information is usable and valid for a HEXCOMMAND.CMD file.

Open an MS-DOS command window and go to the project directory. If a Hex Command file is created from the above, then execute the following: C:\ti\MyProjects\yourproject>> HEX500 HEXCOMMAND.CMD

This will create a hex file for the project. The name will be YOURS.m00.

Program the Flash on the DSK

Finally, the routine is ready to be programmed into the DSK's Flash. From within the MS-DOS command window change directory to where the DSK Utilities are located. (typically: C:\ti\c5400\dsk\utilities)

Be sure to close Code Composer, power down the VC5402 DSK, Jumper Pins 1 and 2 on the JP2 connector and power up the VC5402 DSK. (Note: Pin 1 on JP2 is the pin on the end of the connector closest to the parallel port connector.)

Execute the following line:

FLASHU 2 -1 c:\ti\myprojects\yourproject\yours.m00

Power down the VC5402 DSK. Remove the jumper on JP2. Re-power the VC5402 DSK and the routine should bootload and run.

Once the Flash on the DSK has completed, power down the VC5402 DSK. Remove the jumper on JP2. Re-power the VC5402 DSK and the routine will boot load and run.

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